

IDA DOCUMENT D-1174

THE DARPA HIGH-PERFORMANCE POLYMER PROGRAM

Volume I. Program Background and Highlights of the Program Review Held on 14-15 January 1992

> David R. Squire, IDA Consultant Loker Hydrocarbon Research Institute University of Southern California

> > George Mayer
> > Institute for Defense Analyses



September 1992

Prepared for
Defense Advanced Research Projects Agency

Approved for public release; distribution unlimited.



INSTITUTE FOR DEFENSE ANALYSES 1801 N. Beauregard Street, Alexandria, Virginia 22311-1772



DEFINITIONS

IDA publishes the following documents to report the results of its work.

Reports

Reports are the most authoritative and most carefully considered products IDA publishes. They normally embody results of major projects which (a) have a direct bearing on decisions affecting major programs. (b) address issues of significant concern to the Executive Branch, the Congress and/or the public, or (c) address issues that have significant economic implications. IDA Reports are reviewed by outside panels of experts to ensure their high quality and relevance to the problems studied, and they are released by the President of IDA.

Group Reports

Group Reports record the findings and results of IDA established working groups and panels composed of senior individuals addressing major issues which otherwise would be the subject of an IDA Report. IDA Group Reports are reviewed by the senior individuals responsible for the project and others as selected by IDA to ensure their high quality and relevance to the problems studied, and are released by the President of IDA.

Papers

Papers, also authoritative and carefully considered products of IDA, address studies that are narrower in scope than those covered in Reports. IDA Papers are reviewed to ensure that they meet the high standards expected of refereed papers in professional journals or formal Agency reports.

Documents

IDA Documents are used for the convenience of the sponsors or the analysts (a) to record substantive work done in quick reaction studies. (b) to record the proceedings of conferences and meetings, (c) to make available preliminary and tentative results of analyses, (d) to record data developed in the course of an investigation, or (e) to forward information that is essentially unanalyzed and unevaluated. The review of IDA Documents is suited to their content and intended use.

The work reported in this document was conducted under contract MDA 903-89 C 0003 for the Department of Defense. The publication of this IDA document does not indicate endorsement by the Department of Defense, nor should the contents be construed as reflecting the official position of that Agency.

REPORT D	Form Approved OMB No. 0704-0188		
completing and reviewing the collection of information. Headquarters Services, Directorate for Information Open	Send comments recently this burden estimate or	any other aspect of this collection of informe	existing data sources, gathering and maintaining the data needed, and ston, including suggestions for reducing this burden, to Washington the Office of Management and Budget, Paparwork Reduction Project
1. AGENCY USE ONLY (Leave blan	k) 2. REPORT DATE	3. REPORT TYPE AND DA	TES COVERED
	September 1992	FinalDecember 1	991 to July 1992
	mance Polymer Program, Vo d Highlights of the Program 992	olume I:	6. FUNDING NUMBERS C - MDA 903 89 C 0003 T- A-131
6. AUTHOR(S) David R. Squire, George	Mayer		
7. PERFORMING ORGANIZATION N Institute for Defense Anal 1801 N. Beauregard St. Alexandria, VA 22311-17	lyses	8	PERFORMING ORGANIZATION REPORT NUMBER IDA Document D-1174, Vol. I
9. SPONSORING/MONITORING AGI Defense Advanced Rese 3701 North Fairfax Drive Arlington, VA 22203-1714	arch Projects Agency	5) 1	0. SPONSORING/MONITORING AGENCY REPORT NUMBER
11. SUPPLEMENTARY NOTES		•	
12a. DISTRIBUTION/AVAILABILITY	STATEMENT	1	2b. DISTRIBUTION CODE
Approved for public relea	se; distribution unlimited.		
13. ABSTRACT (Maximum 200 word	ds)		
has instigated research in resins for 700°F composit piezoelectric sensors. Vo DARPA High-Performanc DARPA on 14-15 January an appendix which provid	te applications, rigid molecu plume I of the present report se Polymer Program and pre	ing such goals as therm lar composites, liquid c reviews the history and esents highlights of the las a comprehensive re nda, a list of participants	nally oxidatively stable matrix rystal displays, and d accomplishments of the program review conducted by eference source document, is s, and copies of selected
14. SUBJECT TERMS			15. NUMBER OF PAGES
polymers, composite mate	erials, matrix materials		33
			16. PRICE CODE
17. SECURITY CLASSIFICATION 1 OF REFORT	18. SECURITY CLASSIFICATION OF THIS PAGE	19. SECURITY CLASSIFICA OF ABSTRACT	TION 20. LIMITATION OF ABSTRACT
UNCLASSIFIED	UNCLASSIFIED	UNCLASSIFIED	SAR

IDA DOCUMENT D-1174

THE DARPA HIGH-PERFORMANCE POLYMER PROGRAM

Volume I. Program Background and Highlights of the Program Review Held on 14-15 January 1992

> David R. Squire, IDA Consultant Loker Hydrocarbon Research Institute University of Southern California

> > George Mayer
> > Institute for Defense Analyses

September 1992

Accesio	n For			
NTIS		V		
DTIC TAB Unannounced T			- !	
Justino		<i></i>		
By Distrib	By Distribution /			
Availability Codes				
Dist	Avail a Spe	•		
A-1				

Approved for public release; distribution unlimited.

DTIC QUALITY INSPECTED 4



INSTITUTE FOR DEFENSE ANALYSES

Contract MDA 903 89 C 0003 DARPA Assignment A-131

FOREWORD

This document was prepared for the Materials Science Division, Defense Sciences Office, Defense Advanced Research Projects Agency, as part of Project Assignment A-131 under the technical cognizance of Dr. Richard T. Loda.

While this document has not been subjected to formal IDA review, it has been read by IDA and DARPA personnel and is believed to be an accurate account.

PREFACE

The Defense Sciences Office of the Defense Advanced Research Projects Agency (DARPA) has conducted a program in high-performance polymers since 1984. A comprehensive review of this program was held on 14-15 January 1992 by Richard T. Loda, the present DARPA program manager, and this report is meant to place that review on record. Volume I of the report covers a brief history of the program, including descriptions of some of the past and pending payoffs, and a discussion of the highlights of the review. Volume II is an appendix which contains selected material from the presentations by the contractors. With this formatting, Volume I is a concise, standalone description (basically an executive summary) of the polymer program, while the appendix, Volume II, is a reference source document where details may be found when needed.

ACKNOWLEDGMENT

The authors hereby acknowledge the yeoman service of John E. Hove, of IDA, in reviewing and substantially editing this report.

ABSTRACT

In a series of projects dating back to 1984, the Defense Advanced Research Projects Agency (DARPA) has instigated research in advanced polymers including such goals as thermally oxidatively stable matrix resins for 700°F composite applications, rigid molecular composites, liquid crystal displays, and piezoelectric sensors. Volume I of the present report reviews the history and accomplishments of the DARPA High-Performance Polymer Program and presents highlights of the program review conducted by DARPA on 14-15 January 1992. Volume II, intended as a comprehensive reference source document, is an appendix which provides the program review agenda, a list of participants, and copies of selected presentation material. Correspondence from the presenters is included with the presentation material where appropriate.

CONTENTS - VOLUME I

Fore	word	ii
Pref	ace	iii
Ack	nowledgment	iv
Absi	ract	v
I.	INTRODUCTION AND HISTORY OF DARPA HIGH- PERFORMANCE POLYMER PROGRAM	I-1
II.	SELECTED PAYOFFS OF THE ADVANCED POLYMER PROGRAM	II-1
III.	HIGHLIGHTS OF THE DARPA REVIEW OF THE HIGH- PERFORMANCE POLYMER PROGRAM	III-1
	A. University of Massachusetts (Karasz) – URI	III-1
	B. University of Massachusetts (MIT/Thomas) – URI	III-1
	C. University of Massachusetts (Foster-Miller/Blizard) – URI	III-2
	D. University of Pennsylvania (MacDiarmid) – URI	III-2
	E. University of Pennsylvania (Ohio State/Epstein) – URI	
	F. University of Pennsylvania (Kent State/West) – URI	
	G. MIT (Cohen) – URI	
	H. University of Texas, Arlington (Pomerantz) – URI	
	I. University of Illinois (Economy)	
	J. University of Illinois (Economy)	
	K. Rutgers University (Scheinbeim)	
	L. University of California (Weber)	
	M. University of Southern Mississippi (McCormick)	
	N. Hoechst Celanese (Glick)	
	O. University of Southern California (Amis)	
	P. VPI (McGrath)	
	Q. Clemson University (Thies)	
	R. Research Triangle Institute (Preston)	
IV.	PROGRAM REVIEW AGENDA AND PARTICIPANTS	TV-1

I. INTRODUCTION AND HISTORY OF THE DARPA HIGH-PERFORMANCE POLYMER PROGRAM

In this volume, this report briefly reviews the history of the polymeric materials program at the Defense Advanced Research Projects Agency (DARPA) and identifies several past or pending payoffs that seem worthy of discussion. It then presents highlights of the DARPA program review conducted 14-15 January 1992 at System Planning Corporation in Arlington, Virginia. Copies of selected material presented at the program review are appended in Volume II.

In the early 1980s, the original push to develop a polymeric materials program at DARPA came from Ben A. Wilcox, Director of the Materials Science Division, Defense Sciences Office. The principal driver was the high-performance composite materials requirements for the Advanced Tactical Fighter (ATF). In 1984, Wilcox brought Phillip A. Parrish on board to oversee the development and implementation of the high-performance polymer program. During this period, with the collaboration of the Air Force, there were two principal thrusts: (1) development of thermally oxidatively stable (TOS) resins that would meet the aircraft industry requirements for 700°F (371°C) composite applications and (2) development of molecular composites in which the reinforcing component is a rigid, long chain molecule molecularly dispersed in flexible coillike molecules.

These programs were quite productive. John Stille at Colorado State University was successful in the synthesis and blending, for the first time ever, of materials that are truly molecular composites, as verified both by physical properties and by x-ray diffraction analyses. These novel materials are based upon the chemistry of polyquinolines. Presently, Maxdem, a company located in Southern California, is promoting their commercialization for electronic packaging.

In the area of TOS polymers, investigators at Hoechst Celanese were successful in developing a resin that is stable to 500°F (260°C) and is both processable and scalable, based upon polybenzimidazole/polyimide (PBI/PI) chemistry. Components made from this resin have higher solvent resistance as well as much higher temperature stability (500°F versus 250°F) than resins presently utilized. James E. McGrath, of the Virginia

Polytechnic Institute, was involved in helping to make this program successful. McGrath has gone on under separate DARPA funding to develop a class of polymeric materials that early results show should perform well in TOS tests at temperatures up to 800°F (427°C). Thus, the DARPA program succeeded in increasing high-temperature oxidation stability far beyond present capabilities.

In 1985, the polymer program at DARPA was markedly enhanced by becoming involved in the University Research Initiative (URI). Through funding provided by this initiative, six major projects were initiated in various areas of polymer research and technology which ranged from basic theoretical investigations to experimental investigations of liquid crystalline polymers and to studies of conducting polymers. While the results of the URI projects are mentioned later, two such projects are worth highlighting here. In one of these, over a 5-ye r period workers at the University of Pennsylvania and Ohio State University developed a conducting polymer from a laboratory curiosity into a stable material that has now been commercialized (by Hexcel and Allied-Signal). The impact of conducting polyaniline for military systems is extensive and ranges from lightning-strike protection to utilization in honeycomb structures in aircraft. Conducting polyanilines are representative of a new class of materials known as synthetic metals. This technology is still discovering new and varied applications in both military systems and the commercial marketplace.

A second URI-funded DARPA project has led to the development of a highly novel display technology that is based upon liquid crystalline polymers. This new technology is expected to largely displace cathode-ray tube (CRT) technology in this decade, as it will be four times brighter and have higher contrast, greater simplicity, and an unlimited viewing angle. An active transition is now ongoing at DARPA in the high-definition display technology program. This has obvious commercial payoffs and, in an effort along these lines, the National Science Foundation (NSF) recently initiated a Science and Technology Center at Kent State which also involves Case Western Reserve and the University of Akron.

In 1988, one of the authors of this report, David R. Squire, joined DARPA with the charter of developing the Materials Chemistry Program and, in particular, expanding the polymer program beyond the ongoing thrusts and the directions of the URI projects. The new efforts brought about the development of materials with enhanced compressive strength properties, the development of supercritical processing technologies, and the development of advanced composites and coatings.

In 1990, Richard T. Loda joined DARPA. Under his management of the Materials Chemistry Program, the Hoechst Celanese effort on high-temperature resin matrices was pushed to a higher level via the support of McGrath at Virginia Polytechnic. A scale-up and demonstration project for this new class of polymers was initiated with Lockheed and Maxdem. The polycarbosilane project at the University of Southern California was nurtured via additional funding and the inclusion of Hercules, and an electronic packaging demonstration is now undergoing development.

The numerous transitions into other DARPA offices, as well as interested involvement by corporations such as Hercules and Owens Corning, indicate the productivity of the polymer program. In brief, this program has led to the development of the following:

- A new class of polymers that perform structural roles well beyond 700°F (371°C)
- A new class of polymeric piezoelectric sensors
- Electrostrictive polyurethanes for application in advanced sonar technology
- Novel drag-reducing polymers for submarine use that have 10 times the efficiency of presently used materials
- High-performance boron nitride fibers
- Low-cost, high-performance carbon fibers from pitch utilizing supercritical fluid technology
- Novel silicon-carbon polymer for electronic packaging, and
- The successful demonstration of the processing of polymers into fibers utilizing supercritical fluid technology.

II. SELECTED PAYOFFS OF THE ADVANCED POLYMER PROGRAM

This section contains graphical and pictorial presentations of several of the DARPA funded projects that either have transitioned or are on the threshold of transitioning from the laboratory to actual applications and in some instances to industrial commercialization. Charts 1 through 6 are abstracted from the copies of the program review presentations given in Volume II of this report. They are self-descriptive and require no captions. The authors of this report have included these charts here in stand-alone form because they could be useful in further transition efforts either to potential DoD customers or to the commercial sector. The charts are as follows:

Chart Number	Subject
1	Synthetic metals using polyaniline chemistry
2*	High-definition liquid crystal displays
3	Polymeric piezoelectric materials
4	Drag-reducing polymers for ship and submarine use
5**	Novel polycarbosilanes for uses such as electronic module encapsulation
6	Ultra-high-temperature performance organic matrix resins and structural adhesives

^{*} Chart 2 uses but does not define the abbreviations VFD and PDP. VFD stands for vacuum fluorescent displays, and PDP stands for plasma display panels.

Additional discussions of the six subject areas covered by the charts will be found in Section III.

^{**} Chart 5 is from the University of Southern California (William P. Weber).

NT FUTURE 2000	CIAL POTENTIAL SALES / SALES \$1 BILLION WORLD-WIDE for SYNTIIETIC METALS	FURING ELECTROMAGNETIC SHIELDING, CABLE SHIELDING, ELECTROSTATIC CONTROL, & RESISTIVE HEATING (Allied-Signal)	CONDUCTING POLYMER FIBERS & FABRICS (Milliken) Illed-Signal)	ILINE	METAL POLYANILINE COMPOSITE HONEYCOMB MATERIAL HIGHER	SELECTIVE GAS SEPARATION MEMBRAN [UCIA / several cop.:s]	\$90 / 1b.
PAST DARPA PRESENT FUTURE 1986 to the Number of the State of Juckhed 1992 2000	IABORATORY CURIOSITY; COMMERCIAL SALES DOPING CIJARACTERIZATION PRODUCTION / SALES \$1 BILLION WORLD-WIDE for (Penn) (Allied-Signal; AmeriChem; Hexcel) SYNTHETIC METALS	COMMERCIAL SALES CHEMICAL Sensors COMMERCIAL SALES CAPACITORS COMMERCIAL SALES CAPACITORS VERSICON*	RECIARGEABLE BATTERIES (Seiko Instru.'s USA) INTIERENTLY CONDUCTIVE POLYMER AIRCRAFT LIGHTNING STRIKE PROTECTION &	HAD A WOIDANCE H. ACKINECUL H. ASTIC COMPOSITES H. ASTIC COMPOSITES	SEALANTS & ADIESIVES (Lockheed) ELECTROMAGNETIC SYNTHETIC METAL SHUTTERS (Lockheed) FOR FILECTROLUMINESCENT (Lockheed) FILECTROLUMINESCENT (Lockheed)	CONTROLLED - RELECTRO - ROBOTICS (Allied-Signal) THERMALLY & THERMALLY STAILE MEDICINE SYSTEMS (1) of Minnesola) N.L.O. PHOTONICS	MODERA' Present: Projected:

Chart 2 ADVANCED DISPLAY MATERIALS

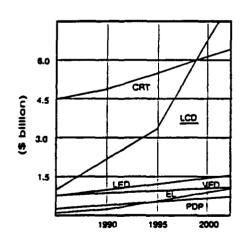
Through the support of DARPA and more recently NSF, Kent State University has trien a leadership role in advancing liquid crystal materials for displays and other electro-optic applications. The most important discoveries have come from the combination of liquid crystals and polymers in the form of dispersions. These materials have led to displays with improved brightness and contrast as well as simplified electric drive schemes at reduced cost. They also make possible new kinds of products such as electrically switchable windows for solar and privacy control.

The Kent program has resulted in some dozen patents (issued or filed) which have been licensed to both small companies (e.g., Polytronix Corp.) and large industries (e.g., General Motors) for product development. Kent's strong patent position on dispersed liquid crystals contributes to U.S. competitiveness in a fiercely competitive international display market. The significance of liquid crystal displays (LCDs) in the world market (see market prediction below) shows that LCD flat-panel displays in general will dominate before the turn of the century.

The possibilities for new and improved dispersions appear endless at this stage of development. For example, a new type of dispersion involving polymer gels was recently discovered at Kent under DARPA University Research Initiative and High Definition Display programs. In reflective displays the new material produces brilliant colors with a contrast exceeding current technology by a factor of five. Gel dispersions create bistable states in the liquid crystals; the result is high resolution displays with simplified electronic drive circuitry.

Displays under development using dispersions:

- High intensity projection systems
- · Large wall-size front-lit displays with memory
- Head-up displays
- High-resolution front-lit flat-panel displays



Projected display market (from DIS-PLAY DEVICES '90) illustrating the growth of various technologies: cathode ray tube (CRT), liquid crystal display (LCD), light emitting diode (LED), and electroluminescence (EL). Chart 3
POLYMER ELECTROPROCESSING LABORATORY
Rulgers, The State University of New Jersey
Co-Directors: Jerry I. Scheinbelm & Brian A. Newman

Estimated Markets:	Atochem Sensors estimate 50-100 million dollars.		Femorieste sylm 5 servers ombudad in schemaci compute wing found above	DARPA/SRI estimate 1-7 billion dollars.	The state of the s	Acoustic Indiana for section search
Applications // Transition:	 embedded in 200° C cured polymer composite materials as stress/strain/failure sensors. smart skins 	3) tough, engine compartment piezoelectric sensors. 4) high temperature, tough, inexpensive, piezoelectric moisture sensors.	Atochem Sensors is licensing odd number nyton piesoelectric technology and developing prototype sensors and circuits.	Basis for Acoustics Radiator for Tactical Search (ARTS) program - DARPA funded program for developing a new long for	sonar projector rests on our discovery of the enormous response of electrostricitye polyurethanes (4,=45 Å/V, static strains-20%)	SRI is developing the prototype acoustic projector (low frequency sonar projector).
Polymer Electroprocessing Laboratory Approach:	Stable ferroelectric/piezoelectric polymers - the odd numbered nylons.			Create and develop a new class of "apparent" piezoelectric materials using high D.C. biased electrostrictive materials. Example: the polymethanes	- Warris	Bade distrantistive response. Bade distrantistive response. Control of polyworkbone as a function of D.C. Man Ridd.
Materials Need: 1) A piezoelectric	polymer which can operate at temperatures ≥ 200° C.			II) A piezoelectric material with thickness coefficient, dr ≥ 5 Å/V	and a modulus	

Chart 4

POLYMERIC DRAG REDUCTION FOR MARINE APPLICATIONS

40% Enhancement of Speed & Range of √Surface Vessels √Submerged Vessels √High Speed Projectiles With Drag Reducing Copolymers from √High-speed fluid shear removal √Regulated addition to surface boundary layer

With Superior Properties that

- $\sqrt{\text{Give}}$ greater drag reduction that traditional homo-polymers
- √ Can be tailored for environmental needs

√ Surface attachment to reduce water friction

- √ Resist shear degradation
- √ Can alter acoustical signature

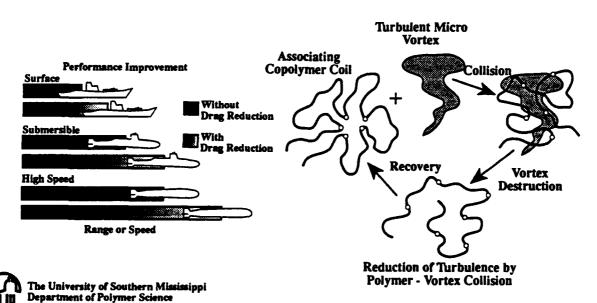


Chart 5

NEW HIGH PERFORMANCE MATERIALS FROM POLY(CARBOSILANES)

(Car	1992 Development of Applications
	1990 1991 Six Patents Filed/One Granted
	1990 Six Patents File
	1989 Patents Developed with Hercules
	1988 Began Synthesis of Novel Si-C Materials

Flectmonic Encaneuriant Materiale		Perfor	Performance Comparisons	parisons
Reliability without Hermaticity	(ne	-Si-C- v material)	Polyimides (candidate)	-Si-C- Polyimides Expoxy (new material) (candidate) (currently used)
✓ Tg is >150°C			•	
• Stable to Thermal Shock (-50 to 150° C)	Dielectric Constant	2.0	28-35	1776
Low Dielectric ~2		}		
Low Moisture Adsorption 0.01%	Moisture Uptake %	0.01	0.8-2.0	2.3
C: Corrosion Barrier Coatings		}) •
Low Moisture Adsorption 0.01% Low Chloride Ion Content	Dissipation Factor	000 000	100-000	5
Composite Materials				
• Ease of Coating (Prepreg)	Coefficient of Thermal			
Carbon Fabric	Expansion	96	20-38	22
 Standard Low Temperature Thermal Cure 				

Novel -Si-C- materials are easily processable, coat microstructures easily, and there is no gas evolution on curing.

Low Dielectric Circuit Boards

Strength in Compression

No Volatiles

Chart 6

ULTRA HIGH TEMPERATURE PERFORMANCE ORGANIC MATRIX RESINS AND STRUCTURAL ADHESIVES

Virginia Polytechnic Institute and State University

1992	 Introduction of PMDA - 3F Diamine Polyimide Tg = 440°C Fabrication into Aircraft Engine Bushings Achieved with Testing at GE
1990/1991	 Achieved 500°F TOS PI/PBI Blends Rear Access Door Demonstration
1989	• Inclusion of University of • Achieved 500°F TOS Massachusetts and VPI PI/PBI Blends Investigators in Project • Rear Access Door • End Capping, 3F and 6F Demonstration Polyimides (Tg = 350°C and 314°C) Introduced
1987	 Initiation of Blending of PBI/PI Hoechst Celanese/GE Lockheed

ACCOMPLISHMENTS AND APPLICATIONS	 Prototype Engine Bushings Tested
STRUCTURES	6F-pPD-PA

Structural Adhesives - 6000 psi lap shear to tlanium achieved

Polymer, Tg ≤ 430°C

Phosphine Oxide

Introduction of

Potential for Titanium Replacement in F-22 and Other Aircraft

· Fire and Oxygen Plasma Resistant Materials

Superior Solar Blankets

Potential for Electronic Packaging/NLO

III. HIGHLIGHTS OF THE DARPA REVIEW OF THE HIGH-PERFORMANCE POLYMER PROGRAM

The DARPA Program Review was held on 14-15 January 1992 at the facilities of the System Planning Corporation in Arlington, Virginia. The agenda and the list of participants are given in Section IV. Copies of selected presentation charts are included in Volume II. Selected technical highlights of the presentations are given below, along with comments by the authors of this report. University Research Initiative programs are identified by the abbreviation URI in the headings.

A. UNIVERSITY OF MASSACHUSETTS (KARASZ) - URI

These researchers have made substantial headway in the development of new characterization techniques including quasi-elastic light scattering (QELS) and forced Rayleigh scattering (FRS) for investigating diffusion in polymers. Their studies of phase relations in polymer blends should impact polymer blend development via enhanced, tailored performance.

B. UNIVERSITY OF MASSACHUSETTS (MIT/THOMAS) - URI

The program under Ned Thomas has led to the discovery of how to make, in a controlled manner, highly oriented microcomposites with unique structures and morphologies. Thomas has successfully scaled up the method to make large samples (5 inches square) in which the microstructure can be oriented in a flow field, nucleates and self-assembles, and yields a single crystal with no grain boundaries. This control of morphology at the microlevel provides a pathway to make high-strength polymers for which the stress-strain behavior can be tailored. This also presents an opportunity to explore the making of thick-section composites using his oscillating shear method. It may be possible to utilize the technique and a back-and-forth rastering procedure that will enable the making of large panels or sections of curvature. Prior to fabrication of large sections, a key issue will be the determination of compressive characteristics.

C. UNIVERSITY OF MASSACHUSETTS (FOSTER-MILLER/BLIZARD) – URI

Ultra-high-performance blends have been made by using a novel melt processing method that requires no solvents and that can easily be scaled up. This new method uses a twin-screw extruder that operates in the 300-400°C temperature range. It will have applications such as making injection-molded parts and making thermoplastic resins for graphite composites that should be stable to temperatures 150°C higher than epoxy. The broader utility of these developments should be evaluated by the services.

D. UNIVERSITY OF PENNSYLVANIA (MacDIARMID) - URI

The first commercialized conducting polymer, manufactured by Hexcel and Allied-Signal, and based on the technology of polyanilines, resulted directly from this program. Widespread military uses are under active study, including replacement of metal in honeycomb structures, conducting adhesives for airframe applications, and conducting coatings for lightning dissipation on aircraft structures. These accomplishments are remarkable in that they brought a laboratory polymer to commercialization in less than 5 years.

High-molecular-weight polyanilines have led to a factor-of-3 improvement in conductivity. Further, blending may lead to an improvement in conductivity by an order of magnitude greater than that for pure polyaniline. The investigation of stretched orientation of polyanilines has resulted in tensile strengths above 300 ksi. Other processing methods that use zone drawing and film casting have also been successful in achieving high orientations that will lead to the development of conducting polymers with excellent mechanical properties.

[Authors' comment: It is suggested that an analysis be conducted to determine the possibility of using conducting polymers in batteries as current collectors, which would lighten the batteries significantly by replacing nickel. Electrically conducting polymers may also find application in fuel-cell developments by providing highly conducting access routes from catalyst sites to electrodes, in effect greatly enhancing electron mobility in both the anode and the cathode. These techniques, as well as synthesis and processing, need to be explored to fully exploit the high electronic conductivity of these polymers.]

E. UNIVERSITY OF PENNSYLVANIA (OHIO STATE/EPSTEIN) - URI

These researchers have discovered that the key to high conductivity is interchain interactions which prevent electron reflection via defects.

Microwave investigations of processing and welding using polyanilines are promising. The advantage of polyanilines is that they act as self-regulating heating elements, preventing thermal runaway. The researchers are presently extending their microwave studies on polymers and blends via investigations of controlled weldability of thermoplastic joints using polyanilines and blends.

Use of polyanilines as biosensors and/or chemical sensors may be possible through electrochemical control of enzyme activity. Sensor work is now under development with Allied-Signal.

[Authors' comment: Exploratory investigations using microwave processing through conducting polymers for joining thermoplastics give promising results and, in particular, avoid thermal runaway difficulties. Welding studies using polyaniline as the adherend have proven successful and have resulted in bond strengths (3000 psi) double those of the prior materials (1500 psi). Fabrication processes, field repair, and time savings may result, as the method is exceptionally fast compared to conventional epoxy methods.]

F. UNIVERSITY OF PENNSYLVANIA (KENT STATE/WEST) - URI

This program in liquid crystalline polymers has led to advances in display technology that are very likely to displace CRT technology in this decade. These researchers have developed displays with unlimited viewing angle, brightness four times that of a CRT, faster response, and higher contrast, as well as lower cost and greater simplicity. The results of this program are being considered for commercialization via joint ventures and are also being transitioned via the High-Definition Display (HDD) Program at DARPA.

The researchers have also developed smart switchable windows that are entering the process of being commercialized. For the military, these developments mean access to brighter and easier to view head-up displays and the possibility of smart canopies and radomes. This is another example of a research opportunity which has transitioned from one DARPA office (Defense Sciences Office, DSO) to another DARPA program (HDD).

G. MIT (COHEN) - URI

This theoretical program has, for the first time, enabled quantitative, atomic-level, first-principles investigations of the origins of plastic deformation in polymeric materials and the prediction of its onset, as well as providing the capability of predicting the mechanical properties of glassy polymers. This fundamental insight could eventually permit the tailoring of polymer systems to have the desired physical properties and to lead to better control of their processing texture formation.

These investigators have determined elements of structure that enhance plastic flow (ductile) versus crazing (premature brittle fracture), which in turn relates closely to issues of aging and embrittlement through atomic-level modeling and design. It was discovered that plastic flow in glassy polymers is by shear. Shear transformations are usually dilatant in nature and thus generate additional free volume. One of the most significant findings resulting from this research is the determination that long-range forces can be attributed to short-range effects. Long-range cooperative motion is extremely important in any analysis at the molecular level.

H. UNIVERSITY OF TEXAS, ARLINGTON (POMERANTZ) - URI

This program has led to the development of a stable and processable conducting polymer, polypyrole, that is compatible with aircraft composites. A fully integrated dipole antenna has been made and successfully tested. This antenna is quite thin and can be incorporated in the surface of an aircraft. These conducting polymers have low band-gaps and are also transparent. They could be considered as candidate materials for fuel-cell and battery applications.

I. UNIVERSITY OF ILLINOIS (ECONOMY)

Synthesis of high-performance B-N fibers has been developed and has led to fibers that have thermal-oxidative stability to 850°C, low dielectric constant (4.0), and should have improved compressive behavior, as the fibers have no microfibrillar morphology, present no accidental release problems (as do carbon fibers), and are stable in metal and ceramic matrices. Starting materials are very low in cost (cents per pound), and a high yield can be obtained (70%). Scale-up of synthesis and processing is being effected by teaming with Owens-Corning Fiberglas; uniform fibers have already been synthesized with diameters of 3, 4, and 6 microns. A dodecane sizing has also been developed that protects

the fiber from moisture and provides handling ease. A new process development includes incorporating a small quantity of silica that extends the temperature stability to 950°C.

J. UNIVERSITY OF ILLINOIS (ECONOMY)

Progress has been made in using polymers that take advantage of a transesterification reaction to form the final product rather than an epoxylike reaction. The researchers are close to realizing their goal, which is high-modulus polymer materials exceeding epoxies for better supporting structures, and use temperatures higher than those of epoxies by 150-200°C. This enables solid-state forming, as no gaseous by-products are formed in the final step. These polyesters should have applications as high-temperature adhesives for bonding aluminum, steel, and titanium. Uses as structural foams, as dielectric insulators, and as corrosion-resistant coatings are other applications. This research is being coupled with industrial partners in FY92.

K. RUTGERS UNIVERSITY (SCHEINBEIM)

Researchers have developed a new class of piezoelectric polymers that is based on odd-numbered nylons. These odd nylons have extraordinary thermal stability as compared to polyvinylidene fluorides (PVF2), which degrade in the 100-135°C range. The odd nylons have stabilities ranging from 185°C for Nylon 11 to 260°C for Nylon 5. Further, the investigators discovered that a blend of PVF2 with an odd nylon has a higher piezoelectric response than the sum of the two components. Uses being explored include sensors built into fiber-reinforced epoxy composites that will sense fatigue and other damage. The researchers have also developed a piezoelectric material that has twice the electromechanical coupling coefficient of the best to date.

Their research has developed polyurethane films that are electrostrictive with properties that should enable the development of highly novel sonar receivers and transmitters that can operate below 100 Hz. A prototype sonar device is now being built in conjunction with the Undersea Warfare Office at DARPA.

L. UNIVERSITY OF CALIFORNIA (WEBER)

A novel class of polymers derived from Si-C chemistry rather than siloxane chemistry has been developed that has properties and processability which have potential for electronic packaging. These properties include very low moisture absorption, no

transport of water, and thermal stability. The dielectric constant is quite low (about 2.0). A prototype demonstration is in process and is being done cooperatively with Hercules and DoD packaging experts. This technology will enable the production of circuit-board laminate components that have low dielectric constants, dimensional stability, and improved resistance to cracking on thermal cycling. [Authors' comment: It is recommended that transitioning to the Electronic Systems Technology Office of DARPA be explored.]

M. UNIVERSITY OF SOUTHERN MISSISSIPPI (McCORMICK)

These investigators have not only made advances in developing insight into the mechanism of action of drag-reduction polymers, but have also developed a quantitative method and a test procedure for comparing relative drag-reducing efficiencies of polymers. Further, they have developed a copolymer of acrylamide that appears to have an order-of-magnitude improvement in efficiency over polyethylene oxide, which is considered to be the baseline material. Their work has the potential for having high military importance. [Authors' comment: In order to more fully determine these possibilities, more information is needed, including:

- 1. What are the present requirements in the Navy for drag reduction in surface ships, submarines, and torpedoes? Specifically:
 - a. Volume and weight of fluids now or projected to be carried on board. Compare McCormick's result with these estimates of weight and volume reduction.
 - b. Cost projection to compare McCormick's material system with what is being used now (or projected for the future).
 - c. General logistic and operational problems.
- 2. Other return on investment:

Reduction in materials screening cost. Find out what costs are now; projected costs of McCormick's test method.

- 3. Calculate drag reduction effects on mission performance for:
 - a. Fuel conservation in peacetime.
 - b. Performance enhancement in warfare scenarios for
 - i. surface ships
 - ii. submarines
 - iii. torpedoes.
- 4. Acoustic signal reduction calculations.
- 5. Can nonsacrificial polymers be bonded to surfaces?

Most of this information is classified, and the authors have not made any effort at such an analysis. They strongly recommend that somebody undertake this study.]

N. HOECHST CELANESE (GLICK)

This team of investigators has successfully made high-temperature oxidation-stable resin to 500°F (260°C) that is processable and scalable and that is based on the polybenzimidazole/polyimide (PBI/PI) system. A 100 lb batch of the 10:90 resin was made and was used to make a high-performance composite component, a rear-access door for the TR1 aircraft, by means of autoclave molding. The resin in this component has much higher solvent resistance as well as much higher temperature stability than resins presently utilized.

These blends, based on PBI/PI, were investigated to overcome some of the inherent problems of PBI and 6F compounds. End capping helped to solve blending problems with Ultem.¹ The researchers have increased T_g so that it now exceeds 300°C; materials are easy to process and have low moisture uptake. However, they exhibit only moderate solvent resistance and are expensive. A more feasible approach that is an outgrowth of this effort is the program now being directed by McGrath at VPI, which has the potential for developing 800°F (427°C) materials.

O. UNIVERSITY OF SOUTHERN CALIFORNIA (AMIS)

For the first time, supercritical fluids have been explored and developed for their unique polymer processing potential (as distinct from fractionation) derived from their extraordinary solvent properties. As much as 10 or more times the weight of polymer can be in solution versus conventional solvents. This enables both blending normally incompatible polymers and eliminating residuals, while dramatically speeding processing. Yields that had been of the order of a few percent have been increased by an order of magnitude. Fibers have been made successfully, and more complex systems will be

¹ Ultem 1000 is a polyether imide with the following chemical structure:

explored, including high-performance fibers, mutually entangled networks, and inorganic-organic networks.

P. VPI (McGRATH)

This program follows on the successes that McGrath helped to bring to the Hoechst Celanese project that had the goal of developing a highly processable high-performance matrix resin with thermal oxidative stability to 700°F. As indicated above in Section III-N, success to 500°F was achieved and a rear-access door demonstration resulted. Under this new program, McGrath has successfully explored new and modified polyimides, processable polybenzoxazoles and new polyimide-modified polyarylene ethers. Already dramatic results have been achieved with the development of PMDA-3F diamine polyimide, which has a glass transition temperature of 842°F (450°C). Prototype engine bushings have been made and are now being tested at General Electric. Lockheed and Maxdem are currently scaling up some of the materials to kilogram quantities to allow for further measurements. Semicrystalline polyimides have also been prepared to investigate the influence of morphology on long-term thermo-oxidative stability (TOS).

McGrath is also developing new processing technology to enhance the processing of polymers with ultrahigh glass transition temperature that is based on the use of fine particles. He has discovered that small-particle dry blends of polymer/metal or polymer/ceramic materials allows direct molding fabrication with the added benefit of eliminating toxic solvents in composites processing.

The VPI team has just recently introduced a new class of high-temperature-stable phosphine oxide polymers that are extremely stable to oxidation. This new class of materials deserves further exploration in view of their outstanding T_g values and fire/oxygen plasma resistance. They also have potential in metal complex hybrid systems.

Q. CLEMSON UNIVERSITY (THIES)

The investigators in this program may have achieved a breakthrough. They have made a high-quality carbon fiber from pitch using supercritical fluid technology for fractionation of the pitch. Composition of the mesophase pitch influences the properties of the resulting carbon fiber. Initial results on fibers made by supercritical fluid (SCF) extraction have resulted in fibers with strengths exceeding those of the best-known pitch-based fibers (Mitsubishi).

Additional emphasis on impurity removal is needed. Sensitivity analysis needs to be done to sort out key variables needing control. These fibers are finding widespread applications in aerospace as well as other industries such as automotive. It remains to optimize the process. This could lead to a low-cost method of making pitch-based high-performance carbon fibers, since petroleum pitch is very inexpensive. It also offers the opportunity for increased reproducibility. A domestic source of high-performance, low-cost carbon fibers is of strategic importance to DoD.

R. RESEARCH TRIANGLE INSTITUTE (PRESTON)

A new high-temperature resin based on ortho linkages in the polymer molecule has been developed with oxidative stability in the 350-400°C range. The investigators have also discovered a new high-strength fiber that is easy to process. Hopefully, more specific data on properties performance will be provided during the forthcoming months.

IV. PROGRAM REVIEW AGENDA AND PARTICIPANTS

The agenda for the 14-15 January 1992 DARPA Review of the High-Performance Polymer Program follows, as does the list of participants. Selected copies of the presentations are appended in Volume II of this report.

DARPA POLYMER PROGRAM REVIEW--JANUARY 14-15, 1992

TUESDAY, JANUARY 14

8:30-8:35	Welcoming Remarks	Ben A. Wilcox, Deputy Director Defense Sciences Office, DARPA
8:35-8:45	Introductory Remarks	Richard T. Loda, Program Manager
8:45-10:00	Univ. of Massachusetts (Karasz)	Chair, Charles Lee, AFOSR
10:00-10:15	BREAK	
10:15-12:15	Univ. of Pennsylvania (MacDiarmid)	**
12:15-1:00	LUNCH	
1:00-2:15	M.I.T. (Argon)	Chair, JoAnn Milliken, NRL
2:15-3:30	Univ. of Texas, Arlington (Pomerantz)	11
3:30-3:40	ADJOURNMENT	
3:45-5:00	Closed Advisory Session	Chair, Richard T. Loda
	WEDNESDAY, JANUAR	<u>Y 15</u>
8:30-9:30	Univ. of Illinois (Economy) (2)	Chair, Kenneth Wynne, ONR
9:30-10:15	Rutgers University (Scheinbeim)	n
10:15-10:30	BREAK	
10:30-11:15	Univ. of Southern California (Weber)	**
11:15-12:00	Univ. of Southern Mississippi (McCormic	ck) "
12:00-12:20	Hoechst Celanese (Glick)	11
12:20-1:00	LUNCH	
1:00-1:45	Univ. of Southern California (Amis)	Chair, Andrew Crowson, ARO
1:45-2:30	VPI and State University (McGrath)	n .
2:30-2:45	BREAK	
2:45-3:30	Clemson University (Thies)	н
3:30-4:15	Research Triangle Institute (Preston)	н
4:15-4:20	ADJOURNMENT	
4:20-5:00	Closed Advisory Session IV-2	Chair, Richard T. Loda

DARPA Polymer Program Review January 14-15, 1992

Professor Eric J. Amis University of Southern California Dept. of Chemistry, SSC 705 Los Angeles, CA 90089-0482 213-740-4113

Dr. Patrick Aubourg Owens-Corning 2790 Columbus Road Granville, OH 43023 614-587-7604

Dr. Edward Balizer Navy Laboratory White Oak (NSWC) Silver Spring, MD 20903-5000 301-394-1444

Dr. Kent G. Blizard Foster-Miller, Inc. 350 Second Avenue Waltham, MA 02154-1196 617-290-0992

Dr. Robert Boschan
Lockheed Aeronautical Systems Co.
Dept. 73C4, Zone 0150, Bldg. B1M
86 South Cobb Drive
Marietta, GA 30063
404-494-9714

Dr. Robert F. Brady Naval Research Laboratory 4555 Overlook Avenue, SW Code 6123 Washington, DC 20375-5000 202-767-2668

Dr. Leonard J. Buckley Naval Air Development Center Code 6064 Warminster, PA 18974 215-441-2823

Dr. Edward Chen Army Research Office P.O. Box 12211 Research Triangle Park, NC 27709 919-549-4325

Dr. Edward C. Chenevy Hoechst Celanese 86 Morris Avenue Summit, NJ 07901 908-522-7806 Professor Robert E. Cohen Massachusetts Institute of Technology 77 Massachusetts Avenue Cambridge, MA 02139-4307 617-253-3777

Dr. Andrew Crowson Army Research Office P.O. Box 12211 Research Triangle Park, NC 27709 919-549-4261

Dr. Ronald DeMarco Office of Naval Research 800 North Quincy Street Arlington, VA 22217-5000 703-696-5075

Dr. Mark A. Druy Foster-Miller, Inc. 350 Second Avenue Waltham, MA 02154-1196 617-290-0992

Dr. James Economy University of Illinois 1304 W. Green Street Urbana, IL 61801 217-333-1440

Professor Ronald L. Elsenbaumer University of Texas at Arlington Dept. of Chemistry, Box 19065 Arlington, TX 76019 817-273-3809

Professor Arthur J. Epstein Ohio State University Dept. of Physics 174 West 18th Avenue, Room 4108 Columbus, OH 43210-1106 614-292-1133

Professor William A. Feld Wright State University Chemistry Dept. Dayton, OH 45435 513-873-2511

Dr. Morton M. Glick Hoechst Celanese 86 Morris Avenue Summit, NJ 07901 908-522-7768 Professor Roger D. Hester University of Southern Mississippi Box 10076, Southern Station Hattiesburg, MS 89406 601-266-4868

Dr. G. Ronald Husk Army Research Office P.O. Box 12211 Research Triangle Park, NC 27709 919-549-4203

Dr. Brian Jensen NASA Langley Research Center MS 226, NASA-LaRC Hampton, VA 23665 804-864-4271

Professor Frank E. Karasz University of Massachusetts Polymer Science Dept., 701 GRT Amherst, MA 01003 413-545-4783

Dr. Teddy M. Keller Naval Research Laboratory 4555 Overlook Avenue, SW Code 6120 Washington, DC 20375-5000 202-767-3095

Dr. Oh-Kil Kim Naval Research Laboratory 4555 Overlook Avenue, SW Code 6120 Washington, DC 20375-5000 202-767-2088

Dr. Charles Lee AFOSR/NC Bolling AFB, DC 20332 202-767-4963

Dr. Raymond Leibfried Hercules Research Center Wilmington, DE 19894 302-995-3126

Dr. George A. Lo Lockheed Missiles and Space Co. 3251 Hanover Street, Polymer Chemistry Palo Alto, CA 94304-1191 415-424-2504

Dr. Richard T. Loda
Defense Advanced Research Projects Agency
3701 North Fairfax Drive - DSO
Arlington, VA 22203-1714
703-696-2283

Professor Alan G. McDiarmid University of Pennsylvania Dept. of Chemistry 343 Chemistry Building Philadelphia, PA 19104-6323 215-898-8307

Professor William J. MacKnight University of Massachusetts Polymer Science Dept., 701 GRT Amherst, MA 01003 413-545-0433

Dr. George Mayer*
Insitute for Defense Analyses
1801 N. Beauregard Street
Alexandria, VA 22311-1772
703-578-2864

Professor Charles L. McCormick University of Southern Mississippi Box 10076, Southern Station Hattiesburg, MS 89406 601-266-4872

Professor James E. McGrath Virginia Polytechnic Institute & State Univ. 2111 Hahn Hall, Mail Stop 0212 Blacksburg, VA 24061-0212 703-231-5976

Dr. JoAnn Milliken Naval Research Laboratory 4555 Overlook Avenue, SW Code 6120 Washington, DC 20375-5000 202-767-3088

Professor Brian A. Newman Rutgers University Dept. of Materials Science & Engineering P.O. Box 909 Piscataway, NJ 08855-0909 908-932-4337

Mr. Joe Piche Foster-Miller, Inc. 350 Second Avenue Waltham, MA 02154-1196 617-290-0992

Professor Martin Pomerantz University of Texas at Arlington Dept. of Chemistry, Box 19065 Arlington, TX 76019 817-273-3811

^{*} Now at University of Pittsburgh.

Dr. Jack Preston Research Triangle Institute P.O. Box 12194 Research Triangle Park, NC 27709-2194 919-541-6384

Professor John R. Reynolds University of Florida Dept. of Chemistry Gainesville, FL 32611 904-392-9151

Dr. Terry L. St. Clair NASA Langley Research Center MS 226, NASA-LaRC Hampton, VA 23665 804-864-4273

Professor Jerry I. Scheinbeim Rutgers University Dept. of Materials Science & Engineering P.O. Box 909 Piscataway, NJ 08855-0909 908-932-3669

Dr. Michael Sennett Army Materials Technology Laboratory Arsenal Street, SLCMT-EMP Watertown, MA 02172-0001 617-923-5122

Dr. Desmond Sheehan Naval Research Laboratory 4555 Overlook Avenue, SW Code 6120 Washington, DC 20375-5000 202-767-2336

Dr. Arthur W. Snow Naval Research Laboratory 4555 Overlook Avenue, SW Code 6120 Washington, DC 20375-5000 202-767-5341

Dr. David R. Squire
University of Southern California
Loker Hydrocarbon Research Institute
University Park
Los Angeles, CA 90089-1661
213-740-6678

Professor Vivian T. Stannett Research Triangle Institute P.O. Box 12194 Research Triangle Park, NC 27709-2194 919-541-6384 Professor Mark C. Thies Clemson University Dept. of Chemical Engineering Clemson, SC 29634 803-656-3056

Professor Edwin L. Thomas Massachusetts Institute of Technology 77 Massachusetts Avenue Cambridge, MA 02139 617-253-6901

Professor William P. Weber University of Southern California Loker Hydrocarbon Research Institute University Park Los Angeles, CA 90089-1661 213-740-5961

Dr. John West Kent State University Liquid Crystal Institute Dept. of Chemistry Kent, OH 44242-0001 216-672-2581

Dr. Ben A. Wilcox Defense Advanced Research Projects Agency 3701 North Fairfax Drive - DSO Arlington, VA 22203-1714 703-696-2241

Dr. Wen-li Wu National Institute of Standards and Technology Building 224, A209 Gaithersburg, MD 20899 301-975-6839

Dr. Kenneth Wynne Office of Naval Research 800 North Quincy Street Arlington, VA 22217-5000 603-696-4409

Mr. Joseph Zegarski Lockheed Missiles and Space Co. 3251 Hanover Street, Polymer Chemistry Palo Alto, CA 94304-1191 415-424-2192